ASSP

Single Serial Input PLL Frequency Synthesizer On-chip 1.2 GHz Prescaler

MB15E03SL

DESCRIPTION

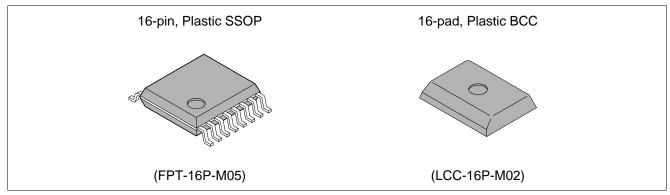
The Fujitsu MB15E03SL is a serial input Phase Locked Loop (PLL) frequency synthesizer with a 1.2 GHz prescaler. The 1.2 GHz prescaler has a dual modulus division ratio of 64/65 or 128/129 enabling pulse swallowing operation. The supply voltage range is between 2.4 V and 3.6 V. The MB15E03SL uses the latest BiCMOS process, as a result, the supply current is typically 2.0 mA at 2.7 V. A refined charge pump supplies a well balanced output currents of 1.5 mA or 6 mA. The charge pump current is selectable by serial data.

MB15E03SL is ideally suited for wireless mobile communications, such as GSM.

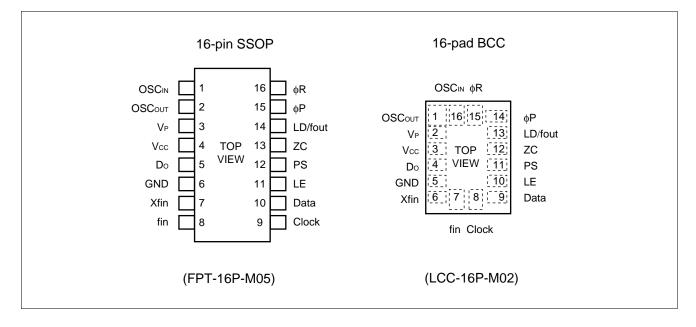
■ FEATURES

- High frequency operation: 1.2 GHz max
- Low power supply voltage: Vcc = 2.4 V to 3.6 V
- Ultra Low power supply current: Icc = 2.0 mA typ. (Vcc = Vp = 2.7 V, Ta = +25°C, in locking state)
 - $I_{CC} = 2.5 \text{ mA typ.}$ ($V_{CC} = V_p = 3 \text{ V}$, $Ta = +25^{\circ}C$, in locking state)
- Direct power saving function: Power supply current in power saving mode
 - Typ. 0.1 μ A (Vcc = Vp = 3 V, Ta = +25°C), Max. 10 μ A (Vcc = Vp = 3 V)
- Dual modulus prescaler: 64/65 or 128/129
- Serial input 14-bit programmable reference divider: R = 3 to 16,383
- Serial input programmable divider consisting of:
 Binary 7-bit swallow counter: 0 to 127
- Binary 11-bit programmable counter: 3 to 2,047
- Selectable charge pump current
- On-chip phase control for phase comparator
- Operating temperature: Ta = -40 to +85°C
- Pin compatible with MB15E03, MB15E03L

PACKAGES



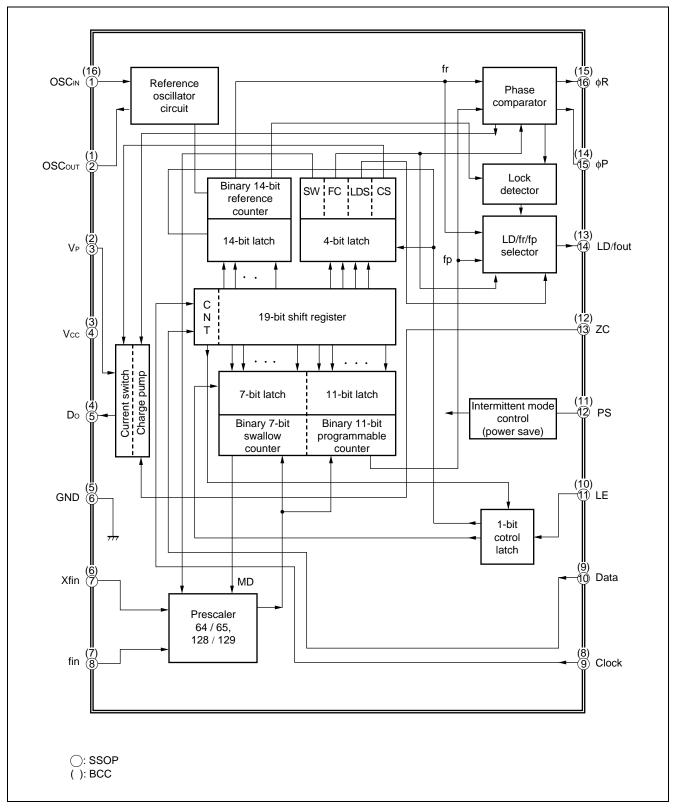
■ PIN ASSIGNMENTS



■ PIN DESCRIPTION

Pin No. Pin I/O				Descriptions
SSOP	BCC	Name	1/0	Descriptions
1	16	OSCIN	I	Programmable reference divider input. Oscillator input connection to a TCXO.
2	1	OSCOUT	0	Oscillator output.
3	2	Vp		Power supply voltage input for the charge pump.
4	3	Vcc		Power supply voltage input.
5	4	Do	0	Charge pump output. Phase of the charge pump can be selected via programming of the FC bit.
6	5	GND		Ground.
7	6	Xfin	I	Prescaler complementary input which should be grounded via a capacitor.
8	7	fin	Ι	Prescaler input. Connection to an external VCO should be done via AC coupling.
9	8	Clock	I	Clock input for the 19-bit shift register. Data is shifted into the shift register on the rising edge of the clock. (Open is prohibited.)
10	9	Data	I	Serial data input using binary code. The last bit of the data is a control bit. (Open is prohibited.)
11	10	LE	I	Load enable signal input. (Open is prohibited.) When LE is set high, the data in the shift register is transferred to a latch according to the control bit in the serial data.
12	11	PS	I	Power saving mode control. This pin must be set at "L" at Power-ON. (Open is prohibited.) PS = "H"; Normal mode PS = "L"; Power saving mode
13	12	ZC	I	Forced high-impedance control for the charge pump (with internal pull up resistor.) ZC = "H"; Normal Do output. ZC = "L"; Do becomes high impedance.
14	13	LD/fout	0	Lock detect signal output (LD)/phase comparator monitoring output (fout). The output signal is selected via programming of the LDS bit. LDS = "H"; outputs fout (fr/fp monitoring output) LDS = "L"; outputs LD ("H" at locking, "L" at unlocking.)
15	14	φP	0	Phase comparator N-channel open drain output for an external charge pump. Phase can be selected via programming of the FC bit.
16	15	φR	0	Phase comparator CMOS output for an external charge pump. Phase can be selected via programming of the FC bit.

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rat	ting	Unit	Remark
Farameter	Symbol	Condition	Min.	Max.	Onit	Relliark
Power supply voltage	Vcc	—	-0.5	4.0	V	
rower supply vollage	Vp	—	Vcc	6.0	V	
Input voltage	Vı	—	-0.5	Vcc +0.5	V	
Output voltage	Vo	Except Do	GND	Vcc	V	
Oulput voltage	Vo	Do	GND	Vp	V	
Storage temperature	Tstg	—	-55	+125	°C	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol		Value	Unit	Remark	
Falameter	Symbol	Min.	Тур.	Max.	Unit	Remark
Power supply veltage	Vcc	2.4	3.0	3.6	V	
Power supply voltage	VP	Vcc	_	5.5	V	
Input voltage	Vı	GND	_	Vcc	V	
Operating temperature	Та	-40		+85	°C	

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

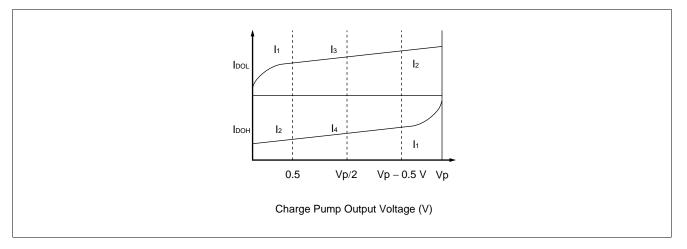
■ ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 2.4 \text{ to } 3.6 \text{ V}, \text{ Ta} = -40 \text{ to } +85^{\circ}\text{C})$

Damamatan		Ourseland	0.00	-1:4:		Value		11
Parameter		Symbol	Con	dition	Min.	Тур.	Max.	Unit
Power supply current*1		Icc*1	$V_{CC} = V_{P} = 2.7 \ (V_{CC} = V_{P} = 3.0)$		_	2.0 (2.5)	_	mA
Power saving current		PS	ZC = "H" or ope	n	—	0.1 ^{*2}	10	μΑ
Operating frequency	fin	fin	-	_	100		1200	MHz
	OSCIN	OSCIN	-	_	3		40	MHz
Input sensitivity	fin⁺³	Vfin	50 Ω system (Refer to the Me cicuit.)	easurment	-15	_	+2	dBm
	$OSC_{IN}^{\star_3}$	Vosc	-	_	0.5	—	Vcc	Vp-p
"H" level input voltage	Data,	Vін	-	_	$Vcc \times 0.7$	—		
"L" level input voltage	Clock, LE, PS, ZC	VIL	-		—	_	$V_{CC} imes 0.3$	V
"H" level input current	Data,	Iıн ^{*4}	-		-1.0	_	+1.0	
"L" level input current	Clock, LE, PS	I IL ^{*4}	-		-1.0	_	+1.0	μA
"H" level input current		Ін	-		0		+100	
"L" level input current	OSCIN	I IL ^{*4}	-	_	-100		0	μA
"H" level input current	70	I ін ^{*4}	-		-1.0	_	+1.0	
"L" level input current	ZC	Iı∟*4	Pull up input		-100	_	0	μA
"L" level output voltage	φP	Vol	Open drain outp	out	_	_	0.4	V
"H" level output voltage	φR,	Vон	$V_{CC} = V_P = 3 V,$	Iон = —1 mA	Vcc - 0.4	—		V
"L" level output voltage	LD/fout	Vol	$V_{CC} = V_P = 3 V,$	lo∟ = 1 mA	—	—	0.4	V
"H" level output voltage	Do	Vdoh	$V_{CC} = V_P = 3 V,$	Іоон = -0.5 mA	V _P - 0.4	—		V
"L" level output voltage	00	Vdol	$V_{CC} = V_P = 3 V,$	Ido∟ = 0.5 mA	—	_	0.4	V
High impedance cutoff current	Do	IOFF	$V_{CC} = V_P = 3 V,$ $V_{OFF} = 0.5 V to V$	VP – 0.5 V	_	—	2.5	nA
"L" level output current	φP	lol	Open drain outp	but	1.0			mA
"H" level output current	ψι,	Іон	-	—		-1.0	mA	
"L" level output current	ĹD/fout	lol	-	_	1.0	—		ШA
"H" level output current		DOH ^{*4}	$V_{CC} = 3 V$, $CS bit = "H"$		—	-6.0		_
	Do	IDOH	$V_P = 3 V,$ CS bit = "L"		—	-1.5		mA
"L" level output current			V _{DO} = V _P /2 Ta = +25°C	CS bit = "H"	—	6.0	—	
		IDUL	CS bit = "L"		—	1.5		
	Idol/Idoh Idomt ^{*5} Vdd = Vp/2			—	3	—	%	
Charge pump current rate	vs Vdo	DOVD ^{*6}	$0.5 \ V \leq V_{DO} \leq V$	⊳ – 0.5 V	—	10	—	%
	vs Ta	DOTA ^{*7}	– 40°C ≤ Ta ≤ +	85°C	_	10	—	%

- *1: Conditions; fin = 1200 MHz, fosc = 12 MHz, Ta = +25°C, in locking state.
- *2: $V_{CC} = V_P = 3.0 \text{ V}$, fosc = 12.8 MHz, Ta = +25°C, in power saving mode
- *3: AC coupling. 1000 pF capacitor is connected under the condition of min. operating frequency.
 *4: The symbol "–" (minus) means direction of current flow.

- *5: $V_{CC} = V_P = 3.0 \text{ V}, \text{ Ta} = +25^{\circ}\text{C} (|I_3| |I_4|) / [(|I_3| + |I_4|) /2] \times 100(\%)$ *6: $V_{CC} = V_P = 3.0 \text{ V}, \text{ Ta} = +25^{\circ}\text{C} [(|I_2| |I_1|) /2] / [(|I_1| + |I_2|) /2] \times 100(\%)$ (Applied to each IDOL, IDOH)
- *7: $V_{CC} = V_P = 3.0 \text{ V}, V_{DO} = V_P/2 (|I_{DO(+85^\circ C)} I_{DO(-40^\circ C)}|/2) / (|I_{DO(+85^\circ C)} + I_{DO(-40^\circ C)}|/2) \times 100(\%)$ (Applied to each IDOL, IDOH)



■ FUNCTIONAL DESCRIPTION

1. Pulse Swallow Function

The divide ratio can be calculated using the following equation:

 $f_{VCO} = [(M \times N) + A] \times f_{OSC} \div R \quad (A < N)$

- fvco : Output frequency of external voltage controlled oscillator (VCO)
- N : Preset divide ratio of binary 11-bit programmable counter (3 to 2,047)
- A : Preset divide ratio of binary 7-bit swallow counter ($0 \le A \le 127$)
- fosc : Output frequency of the reference frequency oscillator
- R : Preset divide ratio of binary 14-bit programmable reference counter (3 to 16,383)
- M : Preset divide ratio of the dual modulus prescaler (64 or 128)

2. Serial Data Input

Serial data is processed using the Data, Clock, and LE pins. Serial data controls the programmable reference divider and the programmable divider separately.

Binary serial data is entered through the Data pin.

One bit of data is shifted into the shift register on the rising edge of the Clock. When the LE pin is taken high, stored data is latched according to the control bit data as follows:

Table 1. Control Bit

Control Bit (CNT)	Destination of Serial Data
н	For the programmable reference divider
L	For the programmable divider

(1) Shift Register Configuration

	F	Progra	amma	able R	efere	nce C	Count	er											
L	.SB ↓								Data	a Flov	/			•				I	MSB ↓
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
	C N T	R 1	R 2	R 3	R 4	R 5	R 6	R 7	R 8	R 9	R 10	R 11	R 12	R 13	R 14	sw	FC	LDS	CS
_	SW FC LD CS	to R1 V S	4 :	Divide Phase LD/fo Chare	e ratio e ratio e cont ut sigi ge pur	settir rol bit nal se np cu	for th lect bi rrent s	for the e pha t	pres se co	caler	(64/65	eferer 5 or 12			(3 to	16,38	3) [Ta [Ta [Ta [Ta	uble 1] uble 2] uble 5] uble 8] uble 7] uble 6]	

	Prog	ramm	able (Count	er													
LSB ↓								Data	a Flov	v —	•							MSB
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
C N T	A 1	A 2	A 3	A 4	A 5	A 6	A 7	N 1	N 2	N 3	N 4	N 5	N 6	N 7	N 8	N 9	N 10	N 11
N1 A1	to A	: Co 11: Di 7 : Di tart da	vide r	atio so atio so	etting	bits fo	or the						2,047)	[Ta	able 1] able 3] able 4]	İ	

Table 2. Binary 14-bit Programmable Reference Counter Data Setting

Divide ratio (R)	R 14	R 13	R 12	R 11	R 10	R 9	R 8	R 7	R 6	R 5	R 4	R 3	R 2	R 1
3	0	0	0	0	0	0	0	0	0	0	0	0	1	1
4	0	0	0	0	0	0	0	0	0	0	0	1	0	0
•	•	•	•	•	•	•	•	•	•	•	•	•	•	•
16383	1	1	1	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 3 is prohibited.

Table 3. Binary 11-bit Programmable Counter Data Setting

Divide ratio (N)	N 11	N 10	N 9	N 8	N 7	N 6	N 5	N 4	N 3	N 2	N 1
3	0	0	0	0	0	0	0	0	0	1	1
4	0	0	0	0	0	0	0	0	1	0	0
•	•				•	•	•				
2047	1	1	1	1	1	1	1	1	1	1	1

Note: • Divide ratio less than 3 is prohibited.

Divide ratio (A)	A 7	A 6	A 5	A 4	A 3	A 2	A 1
0	0	0	0	0	0	0	0
1	0	0	0	0	0	0	1
•	•						
127	1	1	1	1	1	1	1

Table 4. Binary 7-bit Swallow Counter Data Setting

Table 5. Prescaler Data Setting

SW	Prescaler Divide Ratio
Н	64/65
L	128/129

Table 6. Charge Pump Current Setting

CS	Current Value
Н	±6.0 mA
L	±1.5 mA

Table 7. LD/fout Output Select Data Setting

LDS	LD/fout Output Signal
Н	fout signal
L	LD signal

(2) Relation between the FC Input and Phase Characteristics

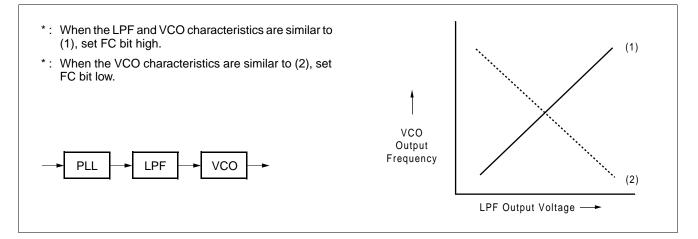
The FC bit changes the phase characteristics of the phase comparator. Both the internal charge pump output level (Do) and the phase comparator output (ϕR , ϕP) are reversed according to the FC bit. Also, the monitor pin (fout) output is controlled by the FC bit. The relationship between the FC bit and each of Do, ϕR , and ϕP is shown below.

Table 8. FC Bit Data Setting (LDS = "H")

	FC = High			FC = Low				
	Do	φR	φP	LD/fout	Do	φR	φP	LD/fout
fr > f⊳	Н	L	L		L	Н	Z*	
fr < f⊳	L	Н	Z*	fout = fr	Н	L	L	fout = fp
fr = f⊳	Z*	L	Z*		Z*	L	Z*	

*: High impedance

When designing a synthesizer, the FC pin setting depends on the VCO and LPF characteristics.



3. Do Output Control

Table 9. ZC Pin Setting

ZC pin	Do output		
Н	Normal output		
L	High impedance		

4. Power Saving Mode (Intermittent Mode Control Circuit)

Table 10. PS Pin Setting

PS pin	Status		
Н	Normal mode		
L	Power saving mode		

The intermittent mode control circuit reduces the PLL power consumption.

By setting the PS pin low, the device enters into the power saving mode, reducing the current consumption. See the Electrical Characteristics chart for the specific value.

The phase detector output, Do, becomes high impedance.

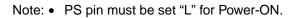
For the signal PLL, the lock detector, LD, remains high, indicating a locked condition.

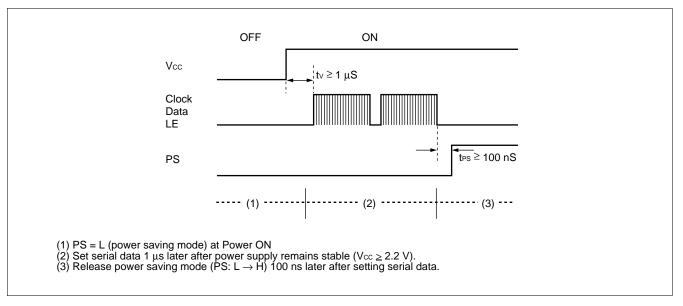
Setting the PS pin high, releases the power saving mode, and the device works normally.

The intermittent mode control circuit also ensures a smooth startup when the device returns to normal operation. When the PLL is returned to normal operation, the phase comparator output signal is unpredictable. This is because of the unknown relationship between the comparison frequency (fp) and the reference frequency (fr) which can cause a major change in the comparator output, resulting in a VCO frequency jump and an increase in lockup time.

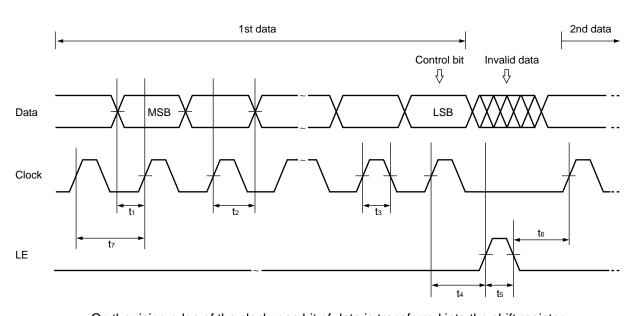
To prevent a major VCO frequency jump, the intermittent mode control circuit limits the magnitude of the error signal from the phase detector when it returns to normal operation.

Note: When power (V_{cc}) is first applied, the device must be in standby mode, PS = Low, for at least 1 μ s.





■ SERIAL DATA INPUT TIMING



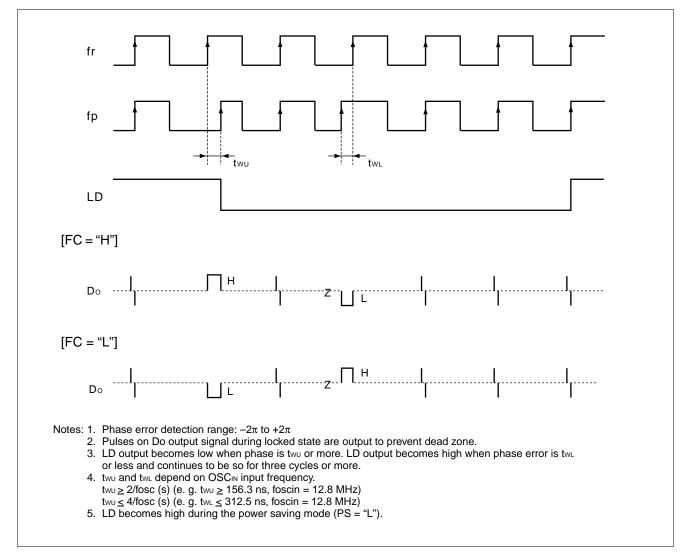
On the rising edge of the clock, one bit of data is transferred into the shift register.

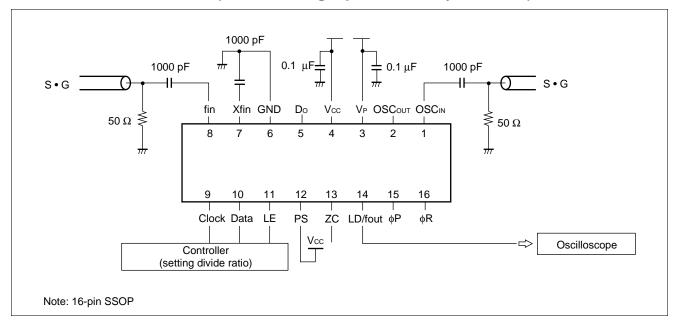
Parameter	Min.	Тур.	Max.	Unit
t1	20			ns
t2	20	_	—	ns
t3	30	_	_	ns
t4	30			ns

Parameter	Min.	Тур.	Max.	Unit
t5	100	_	_	ns
t6	20			ns
t7	100			ns

Note: LE should be "L" when the data is transferred into the shift register.

■ PHASE COMPARATOR OUTPUT WAVEFORM

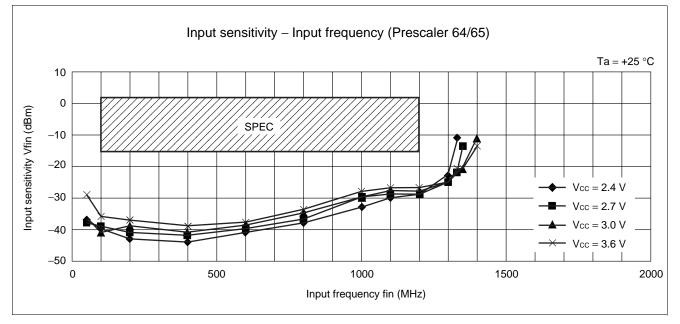




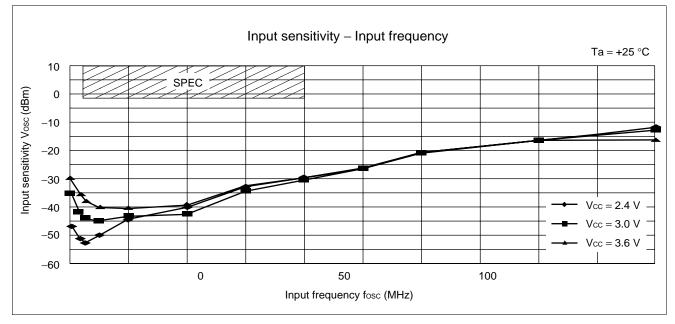
■ MEASURMENT CIRCUIT (for Measuring Input Sensitivity fin/OSC_{IN})

■ TYPICAL CHARACTERISTICS

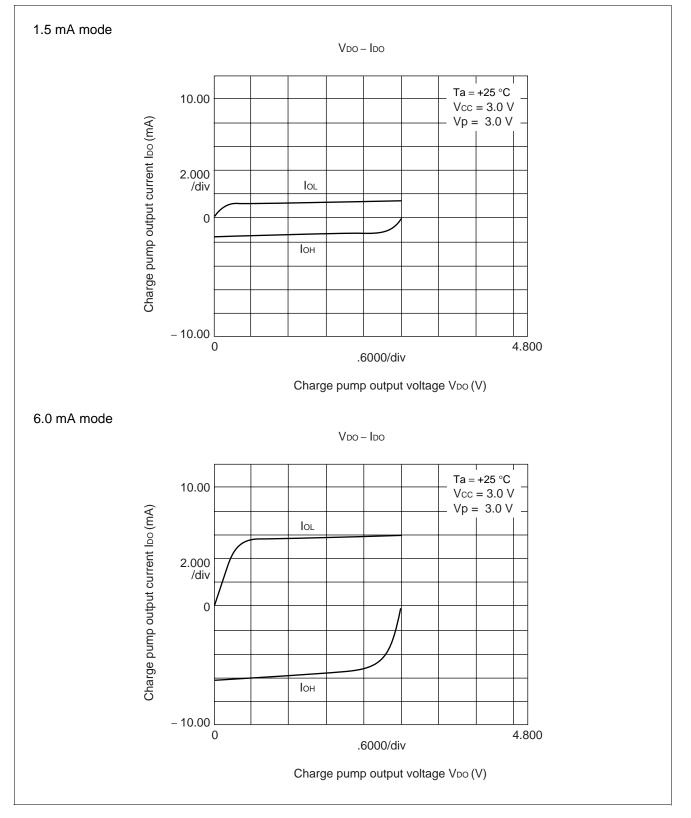
1. fin input sensitivity



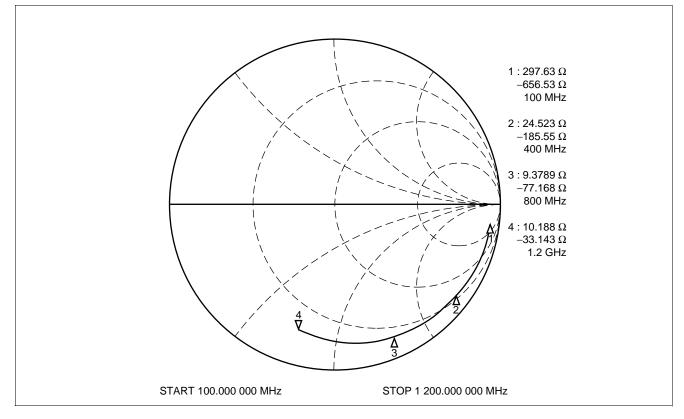
2. OSCIN input sensitivity



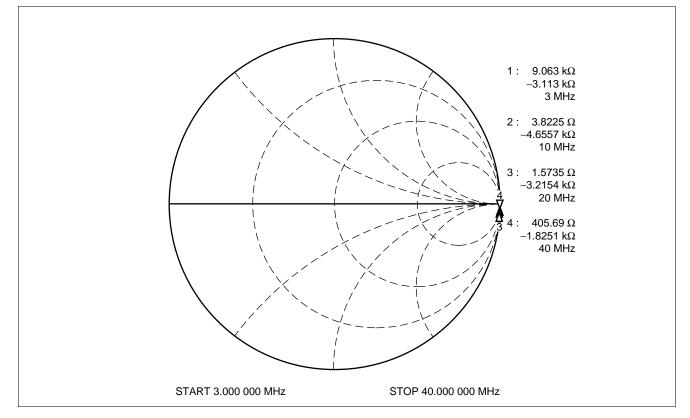
3. Do output current

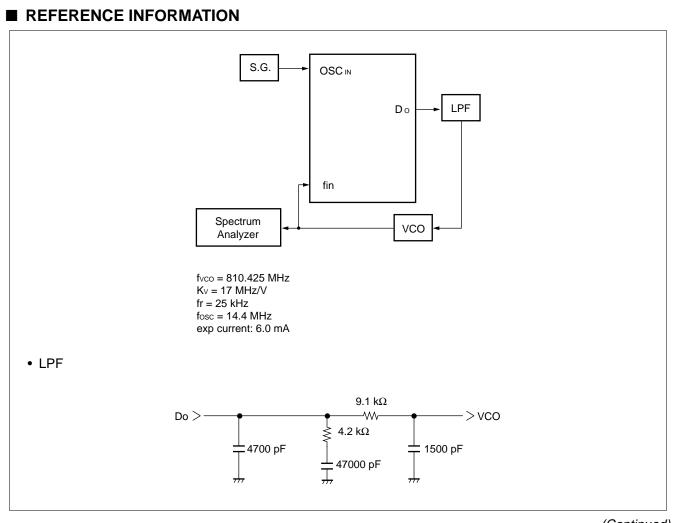


4. fin input impedance

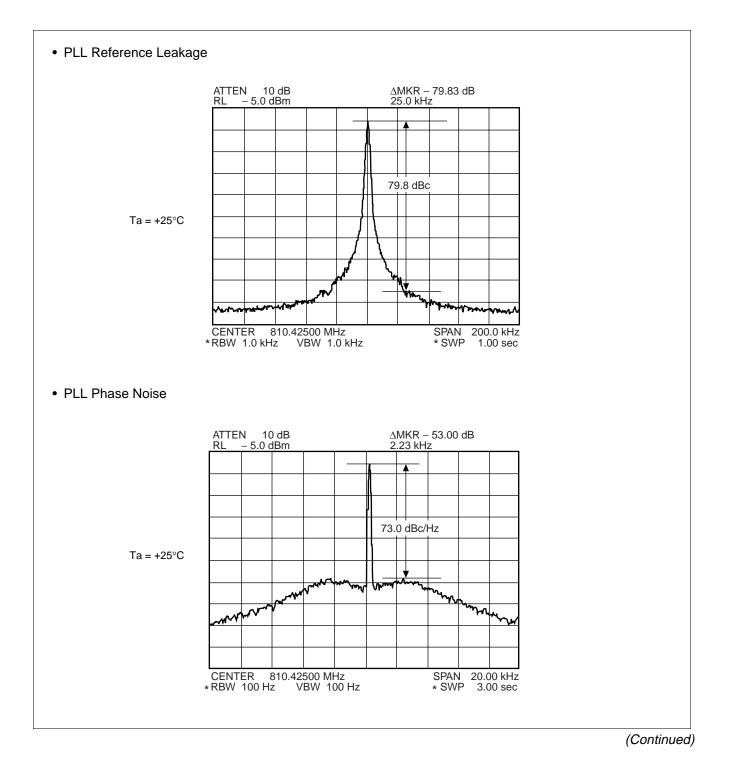


5. OSCIN input impedance

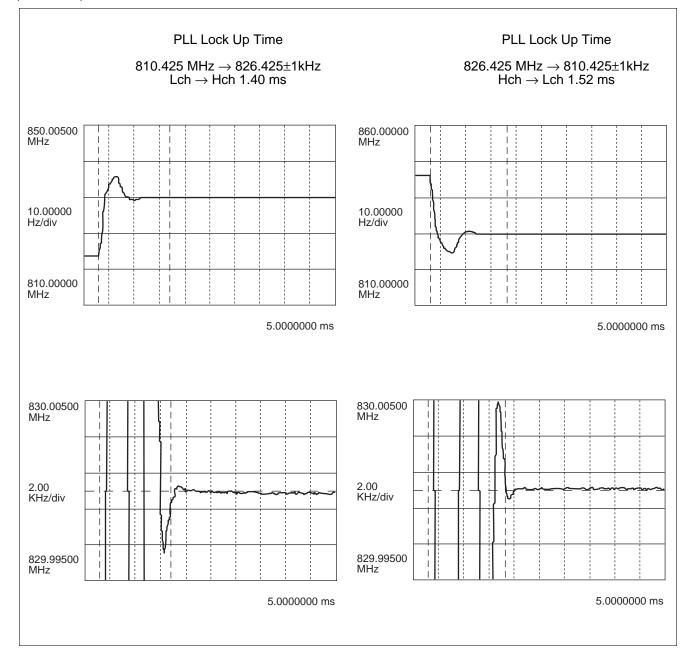




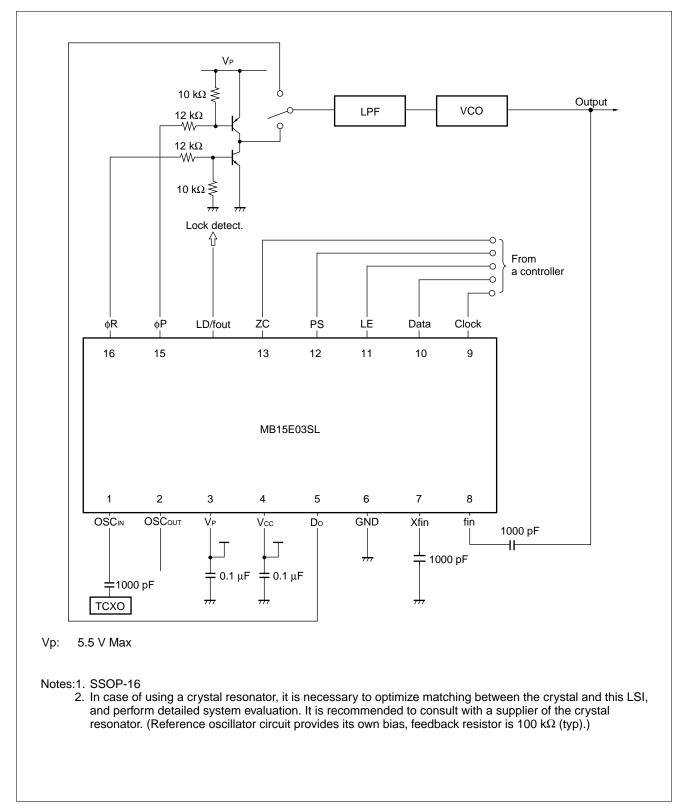
(Continued)



(Continued)



■ APPLICATION EXAMPLE



■ USAGE PRECAUTIONS

To protect against damage by electrostatic discharge, note the following handling precautions: -Store and transport devices in conductive containers.

-Use properly grounded workstations, tools, and equipment.

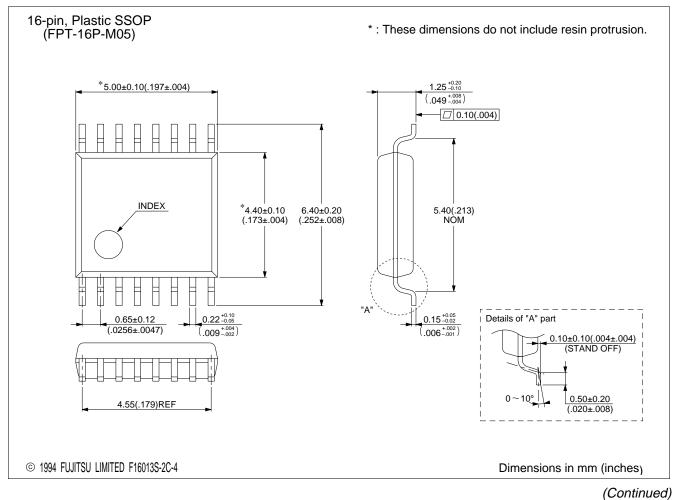
-Turn off power before inserting device into or removing device from a socket.

-Protect leads with a conductive sheet when transporting a board-mounted device.

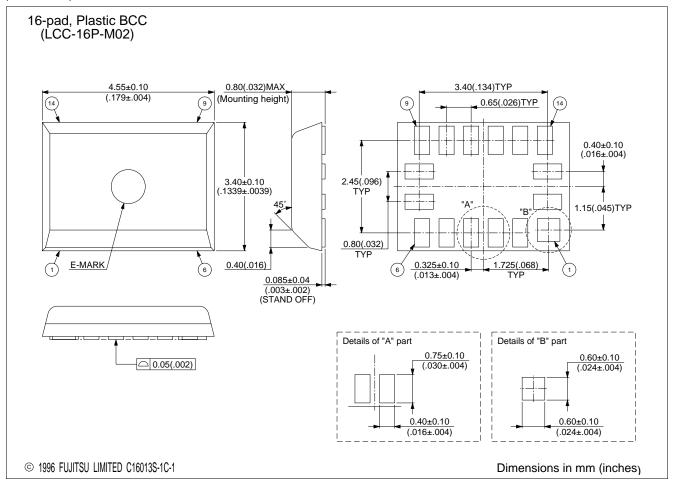
ORDERING INFORMATION

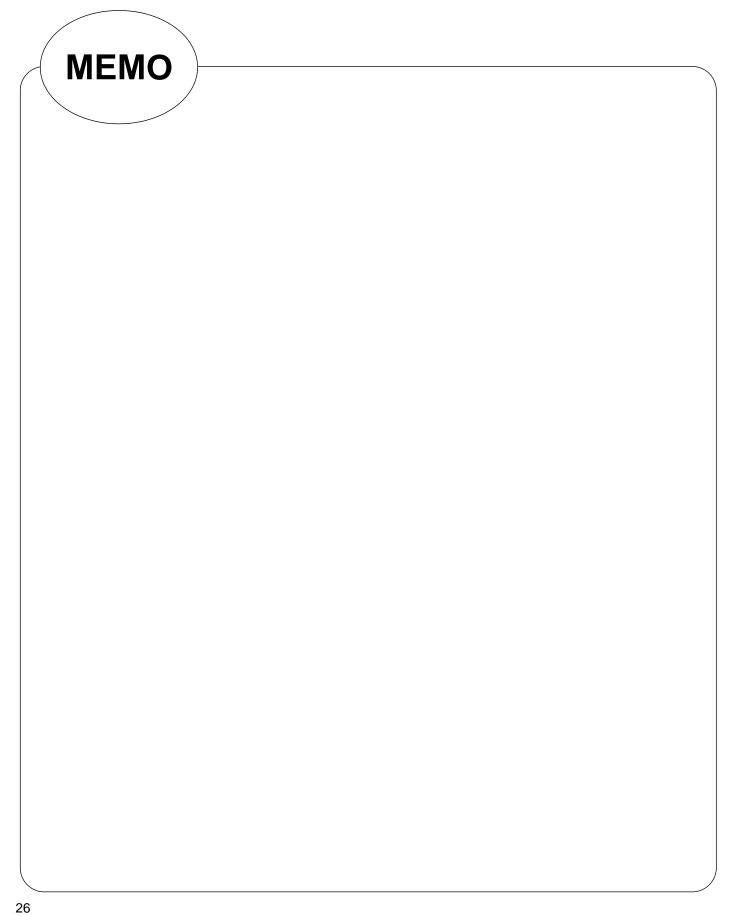
Part number	Package	Remarks
MB15E03SLPFV1	16-pin, Plastic SSOP (FPT-16P-M05)	
MB15E03SLPV	16-pad, Plastic BCC (LCC-16P-M02)	

■ PACKAGE DIMENSIONS



(Continued)







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